



- Note:
- Material:
 - Housing: High temperature thermoplastic with g.f,UL94V-0
 - Contact: copper alloy,t=0.20mm
 - Shell: copper alloy,t=0.25mm
 - Specification:
 - Current rating: 1 A Max.
 - Dielectric withstanding voltage: 100 V(ac) for 1 min.
 - Contact resistance: 50 mW Max.
 - Insulation resistance: 100 MW Min.
 - Total mating force: 3.57 Kgf Max.
 - Total unmating force: 1.0 Kgf Min. Kgf Min.after 10000 insertion/extrati
 - Temperature range: -30°C~80°C

No.	PART NAME	QTY	MATERIAL	REMARK
3	SHELL	1	COPPER ALLOY	TIN PLATED
2	CONTI	5	COPPER ALLOY	G/F AU/TIN PLATED
1	HOUSING	1	THERMOPLASTIC	(UL 94V-0) BLACK

CELLION SAS

DESCRIPTION MICRO USB5P SMT 外壳 内DIP脚

DRAWING NO BT140525006 PART NO. BUSF05B1T11S1

THIRD ANGLE PROJECTION	REVISION	A	UNIT	MM	DRAWN	ROGERLAN
	LINEAR	±0.50	ANGLE	±5°	SCALE	N/A
	XX	±0.38	XX	±2°	SHEET	1/1
	XXX	±0.25	XXX	±1°	CHECKED	APPROVED